

AO4414 N-Channel Enhancement Mode Field Effect Transistor

General Description

The AO4414 uses advanced trench technology to provide excellent R_{DS(ON)} and low gate charge. This device is suitable for use as a load switch or in PWM applications. The source leads are separated to allow a Kelvin connection to the source, which may be used to bypass the source inductance. *Standard Product AO4414 is Pb-free (meets ROHS & Sony 259 specifications). AO4414L is a Green Product ordering option. AO4414 and AO4414L are electrically identical.*

Features

V_{DS} (V) = 30V

 $I_{D} = 8.5A (V_{GS} = 10V)$

 $\mathsf{R}_{\mathsf{DS}(\mathsf{ON})} < 26 \mathrm{m}\Omega \; (\mathsf{V}_\mathsf{GS} = \mathsf{10V})$

 $R_{DS(ON)}$ < 40m Ω (V_{GS} = 4.5V)





	n Ratings T _A =25°C un				
Parameter		Symbol	Maximum	Units	
Drain-Source Voltage		V _{DS}	30	V	
Gate-Source Voltage		V _{GS}	±20	V	
Continuous Drain	T _A =25°C		8.5		
Current ^A	T _A =70°C	I _D	7.1	A	
Pulsed Drain Current ^B		I _{DM}	50		
	T _A =25°C	D	3		
Power Dissipation	T _A =70°C		2.1	W	
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	°C	

Thermal Characteristics								
Parameter	Symbol	Тур	Max	Units				
Maximum Junction-to-Ambient ^A	t ≤ 10s	R _{0JA}	31	40	°C/W			
Maximum Junction-to-Ambient ^A	Steady-State	κ _{θJA}	59	75	°C/W			
Maximum Junction-to-Lead ^C	Steady-State	$R_{ ext{ heta}JL}$	16	24	°C/W			

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Тур	Max	Units
STATIC F	PARAMETERS	-					
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250μA, V _{GS} =0V		30			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =24V, V _{GS} =0V			0.004	1	
			T _J =55°C			5	μA
I _{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} = ±20V				100	nA
V _{GS(th)}	Gate Threshold Voltage	$V_{DS}=V_{GS}$ I _D =250µA		1	1.9	3	V
I _{D(ON)}	On state drain current	V _{GS} =4.5V, V _{DS} =5V		20			Α
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =8.5A			20	26	mΩ
			T _J =125°C		29.2	38	
		V _{GS} =4.5V, I _D =5A			31	40	mΩ
g _{FS}	Forward Transconductance	V_{DS} =5V, I_{D} =5A		10	17		S
V _{SD}	Diode Forward Voltage	I _S =1A,V _{GS} =0V			0.76	1	V
ls	Maximum Body-Diode Continuous Current					4.3	А
DYNAMIC	C PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =15V, f=1MHz			680	820	pF
C _{oss}	Output Capacitance				102		pF
C _{rss}	Reverse Transfer Capacitance				77		pF
R _g	Gate resistance	V_{GS} =0V, V_{DS} =0V, f=1MHz			3	3.6	Ω
SWITCHI	NG PARAMETERS	·					
Q _g (10V)	Total Gate Charge				13.84	17	nC
Q _g (4.5V)	Total Gate Charge	-V _{GS} =10V, V _{DS} =15V, I _D =8.5A			6.74	8.1	nC
Q _{gs}	Gate Source Charge				1.84		nC
Q_{gd}	Gate Drain Charge				3.32		nC
t _{D(on)}	Turn-On DelayTime	V _{GS} =10V, V _{DS} =15V, R _L =1.8Ω, R _{GEN} =3Ω			4.5	6.5	ns
t _r	Turn-On Rise Time				4.2	6.3	ns
t _{D(off)}	Turn-Off DelayTime				20.1	30	ns
t _f	Turn-Off Fall Time				4.9	7.5	ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =8.5A, dI/dt=100A/μs			17.2	21	ns
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =8.5A, dl/dt=100A/μs			8.6	10	nC

A: The value of R_{BUA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^{\circ}C$. The value in any given application depends on the user's specific board design. The current rating is based on the t \leq 10s thermal resistance rating. B: Repetitive rating, pulse width limited by junction temperature.

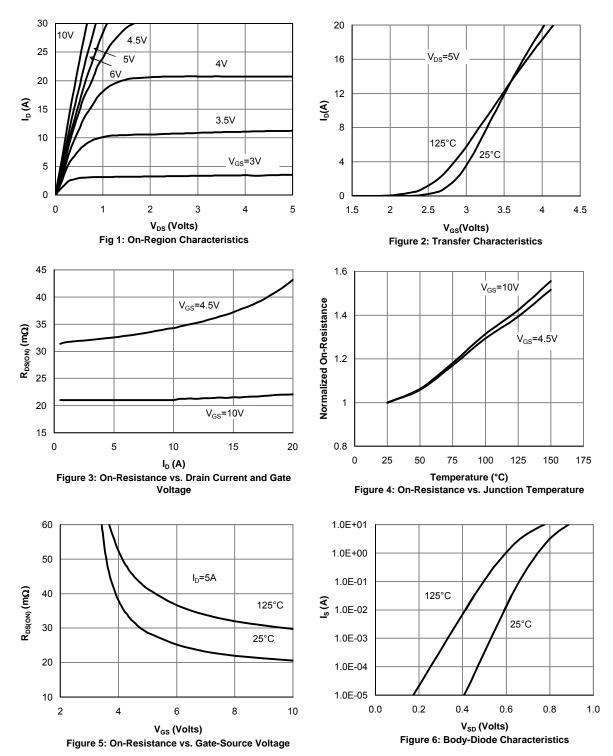
C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using 80 µs pulses, duty cycle 0.5% max.

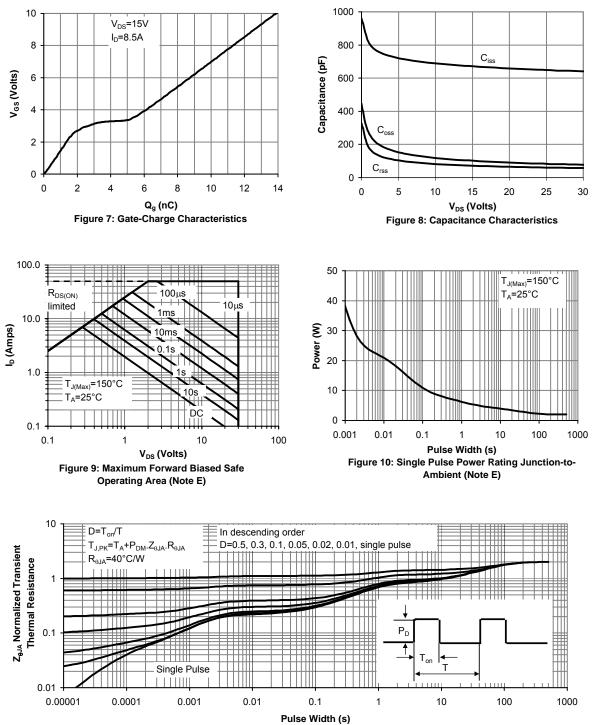
E. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^{\circ}$ C. The SOA curve provides a single pulse rating.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



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